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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1024
Total RAM Bits	8192
Number of I/O	256
Number of Gates	30000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C
Package / Case	304-BFQFP
Supplier Device Package	304-PQFP (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at40k20al-1fqc

Table 1. AT40KAL Family[1]

Device	AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL
Usable Gates	5K - 10K	10K - 20K	20K - 30K	40K - 50K
Rows x Columns	16 x 16	24 x 24	32 x 32	48 x 48
Cells	256	576	1,024	2,304
Registers	496[1]	954[1]	1,520[1]	3,048[1]
RAM Bits	2,048	4,608	8,192	18,432
I/O (Maximum)	128	192	256	384

Note: 1. Packages with FCK will have 8 less registers.

Description

The AT40KAL is a family of fully PCI-compliant, SRAM-based FPGAs with distributed 10 ns programmable synchronous/asynchronous, dual-port/single-port SRAM, 8 global clocks, Cache Logic ability (partially or fully reconfigurable without loss of data), automatic component generators, and range in size from 5,000 to 50,000 usable gates. I/O counts range from 128 to 384 in industry standard packages ranging from 84-pin PLCC to 352-ball Square BGA, and support 3.3V designs.

The AT40KAL is designed to quickly implement high-performance, large gate count designs through the use of synthesis and schematic-based tools used on a PC or Sun platform. Atmel's design tools provide seamless integration with industry standard tools such as Synplicity, ModelSim, Exemplar and Viewlogic. See the "IDS Datasheet" available on the Atmel web site (http://www.atmel.com/atmel/acrobat/doc1421.pdf) for a list of other supported tools.

The AT40KAL can be used as a coprocessor for high-speed (DSP/processor-based) designs by implementing a variety of computation intensive, arithmetic functions. These include adaptive finite impulse response (FIR) filters, fast Fourier transforms (FFT), convolvers, interpolators and discrete-cosine transforms (DCT) that are required for video compression and decompression, encryption, convolution and other multimedia applications.

Fast, Flexible and Efficient SRAM

The AT40KAL FPGA offers a patented distributed 10 ns SRAM capability where the RAM can be used without losing logic resources. Multiple independent, synchronous or asynchronous, dual-port or single-port RAM functions (FIFO, scratch pad, etc.) can be created using Atmel's macro generator tool.

Fast, Efficient Array and Vector Multipliers

The AT40KAL's patented 8-sided core cell with direct horizontal, vertical and diagonal cell-to-cell connections implements ultra fast array multipliers without using any busing resources. The AT40KAL's Cache Logic capability enables a large number of design coefficients and variables to be implemented in a very small amount of silicon, enabling vast improvement in system speed at much lower cost than conventional FPGAs.

Cache Logic Design

The AT40KAL, AT6000 and FPSLIC families are capable of implementing Cache Logic (dynamic full/partial logic reconfiguration, without loss of data, on-the-fly) for building adaptive logic and systems. As new logic functions are required, they can be loaded into the logic cache without losing the data already there or disrupting the operation of the rest of the chip; replacing or complementing the active logic. The AT40KAL can act as a reconfigurable coprocessor.

Automatic Component Generators

The AT40KAL FPGA family is capable of implementing user-defined, automatically generated, macros in multiple designs; speed and functionality are unaffected by the macro orientation or density of the target device. This enables the fastest, most predictable and efficient FPGA design approach and minimizes design risk by reusing already proven functions. The Automatic Component Generators work seamlessly with industry standard schematic and synthesis tools to create the fastest, most efficient designs available.

The patented AT40KAL series architecture employs a symmetrical grid of small yet powerful cells connected to a flexible busing network. Independently controlled clocks and resets govern every column of cells. The array is surrounded by programmable I/O.

Devices range in size from 5,000 to 50,000 usable gates in the family, and have 256 to 3,048 registers. Pin locations are consistent throughout the AT40KAL series for easy design migration in the same package footprint. The AT40KAL series FPGAs utilize a reliable 0.35µ triple-metal, CMOS process and are 100% factory-tested. Atmel's PC- and workstation-based integrated development system (IDS) is used to create AT40KAL series designs. Multiple design entry methods are supported.

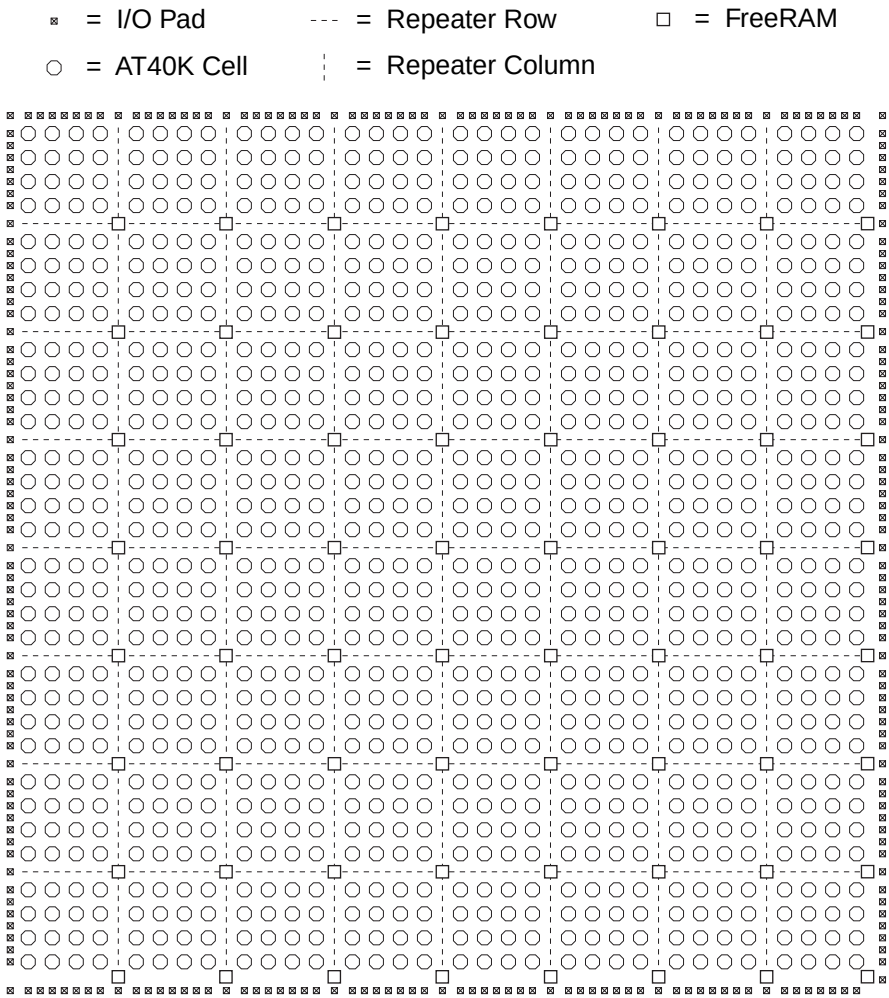
The Atmel architecture was developed to provide the highest levels of performance, functional density and design flexibility in an FPGA. The cells in the Atmel array are small, efficient and can implement any pair of Boolean functions of (the same) three inputs or any single Boolean function of four inputs. The cell's small size leads to arrays with large numbers of cells, greatly multiplying the functionality in each cell. A simple, high-speed busing network provides fast, efficient communication over medium and long distances.

The Symmetrical Array

At the heart of the Atmel architecture is a symmetrical array of identical cells, see Figure 1. The array is continuous from one edge to the other, except for bus repeaters spaced every four cells, see Figure 2 on page 5. At the intersection of each repeater row and column there is a 32 x 4 RAM block accessible by adjacent buses. The RAM can be configured as either a single-ported or dual-ported RAM(1), with either synchronous or asynchronous operation.

Note: 1. The right-most column can only be used as single-port RAM.

Figure 1. Symmetrical Array Surrounded by I/O (AT40K20AL)(1)

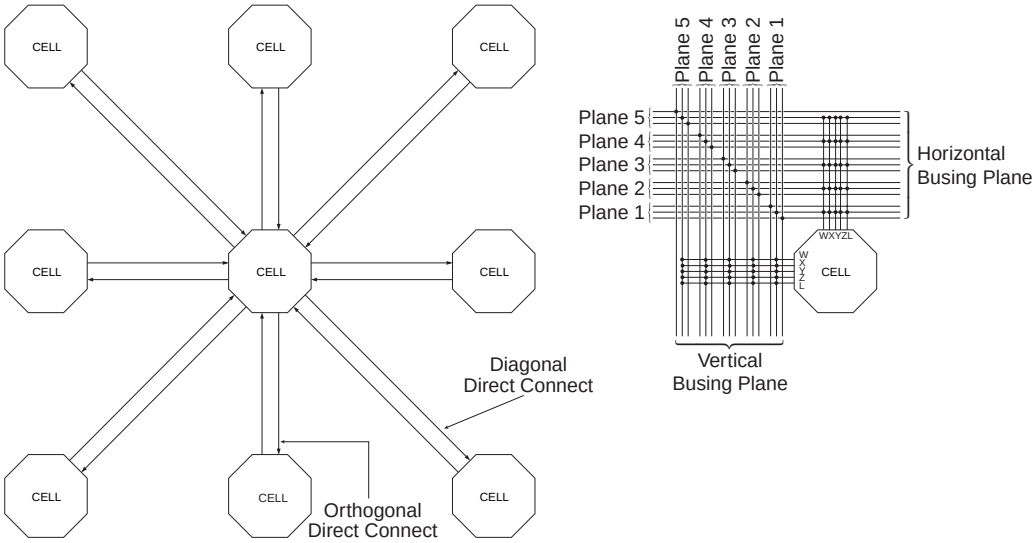


Note: 1. AT40KAL has registered I/Os. Group enable on every sector for tri-states on obufe's.

Cell Connections

Figure 4(a) depicts direct connections between a cell and its eight nearest neighbors. Figure 4(b) shows the connections between a cell and five horizontal local buses (1 per busing plane) and five vertical local buses (1 per busing plane).

Figure 4. Cell Connections



(a) Cell-to-cell Connections

(b) Cell-to-bus Connections

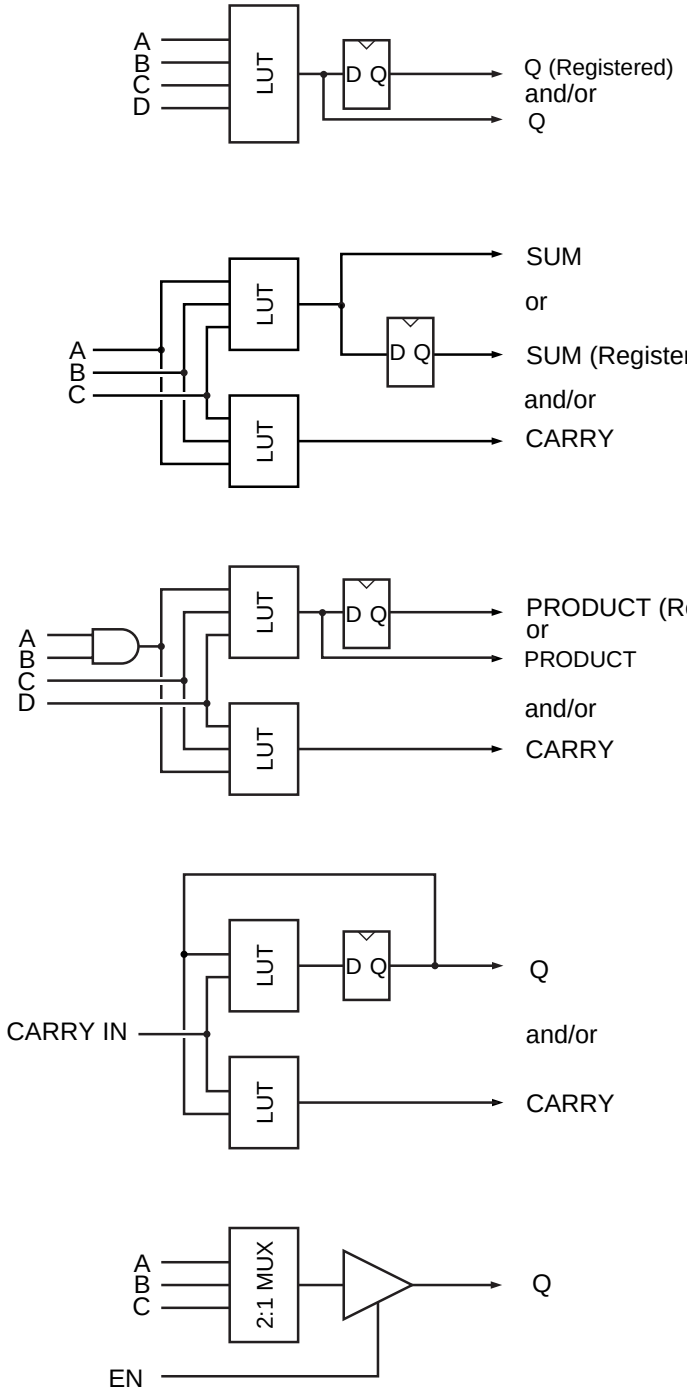
The Cell

Figure 5 depicts the AT40KAL cell. Configuration bits for separate muxes and pass gates are independent. All permutations of programmable muxes and pass gates are legal. V_n (V_1 - V_5) is connected to the vertical local bus in plane n. H_n (H_1 - H_5) is connected to the horizontal local bus in plane *n*. A local/local turn in plane n is achieved by turning on the two pass gates connected to V_n and H_n. Pass gates are opened to let signals into the cell from a local bus or to drive a signal out onto a local bus. Signals coming into the logic cell on one local bus plane can be switched onto another plane by opening two of the pass gates. This allows bus signals to switch planes to achieve greater route ability. Up to five simultaneous local/local turns are possible.

The AT40KAL FPGA core cell is a highly configurable logic block based around two 3-input LUTs (8 x 1 ROM), which can be combined to produce one 4-input LUT. This means that any core cell can implement two functions of 3 inputs or one function of 4 inputs. There is a Set/Reset D flip-flop in every cell, the output of which may be tri-stated and fed back internally within the core cell. There is also a 2-to-1 multiplexer in every cell, and an upstream AND gate in the “front end” of the cell. This AND gate is an important feature in the implementation of efficient array multipliers.

With this functionality in each core cell, the core cell can be configured in several “modes”. The core cell flexibility makes the AT40KAL architecture well suited to most digital design application areas, see Figure 6.

Figure 6. Some Single Cell Modes



Synthesis Mode. This mode is particularly important for the use of VHDL/Verilog design. VHDL/Verilog Synthesis tools generally will produce as their output large amounts of random logic functions. Having a 4-input LUT structure gives efficient random logic optimization without the delays associated with larger LUT structures. The output of any cell may be registered, tri-stated and/or fed back into a core cell.

Arithmetic Mode is frequently used in many designs. As can be seen in the figure, the AT40KAL core cell can implement a 1-bit full adder (2-input adder with both Carry In and Carry Out) in one core cell. Note that the sum output in this diagram is registered. This output could then be tri-stated and/or fed back into the cell.

DSP/Multiplier Mode. This mode is used to efficiently implement array multipliers. An array multiplier is an array of bitwise multipliers, each implemented as a full adder with an upstream AND gate. Using this AND gate and the diagonal interconnects between cells, the array multiplier structure fits very well into the AT40KAL architecture.

Counter Mode. Counters are fundamental to almost all digital designs. They are the basis of state machines, timing chains and clock dividers. A counter is essentially an increment by one function (i.e., an adder), with the input being an output (or a decode of an output) from the previous stage. A 1-bit counter can be implemented in one core cell. Again, the output can be registered, tri-stated and/or fed back.

Tri-state/Mux Mode. This mode is used in many telecommunications applications, where data needs to be routed through more than one possible path. The output of the core cell is very often tri-statable for many inputs to many outputs data switching.

RAM

32 x 4 dual-ported RAM blocks are dispersed throughout the array, see Figure 7. A 4-bit Input Data Bus connects to four horizontal local buses distributed over four sector rows (plane 1). A 4-bit Output Data Bus connects to four horizontal local buses distributed over four sector rows (plane 2). A 5-bit Input Address Bus connects to five vertical express buses in the same column. A 5-bit Output Address Bus connects to five vertical express buses in the same column. Ain (input address) and Aout (output address) alternate positions in horizontally aligned RAM blocks. For the left-most RAM blocks, Aout is on the left and Ain is on the right. For the right-most RAM blocks, Ain is on the left and Aout is tied off, thus it can only be configured as a single port. For single-ported RAM, Ain is the READ/WRITE address port and Din is the (bi-directional) data port. Right-most RAM blocks can be used only for single-ported memories. WEN and OEN connect to the vertical express buses in the same column.

Figure 7. RAM Connections (One Ram Block)

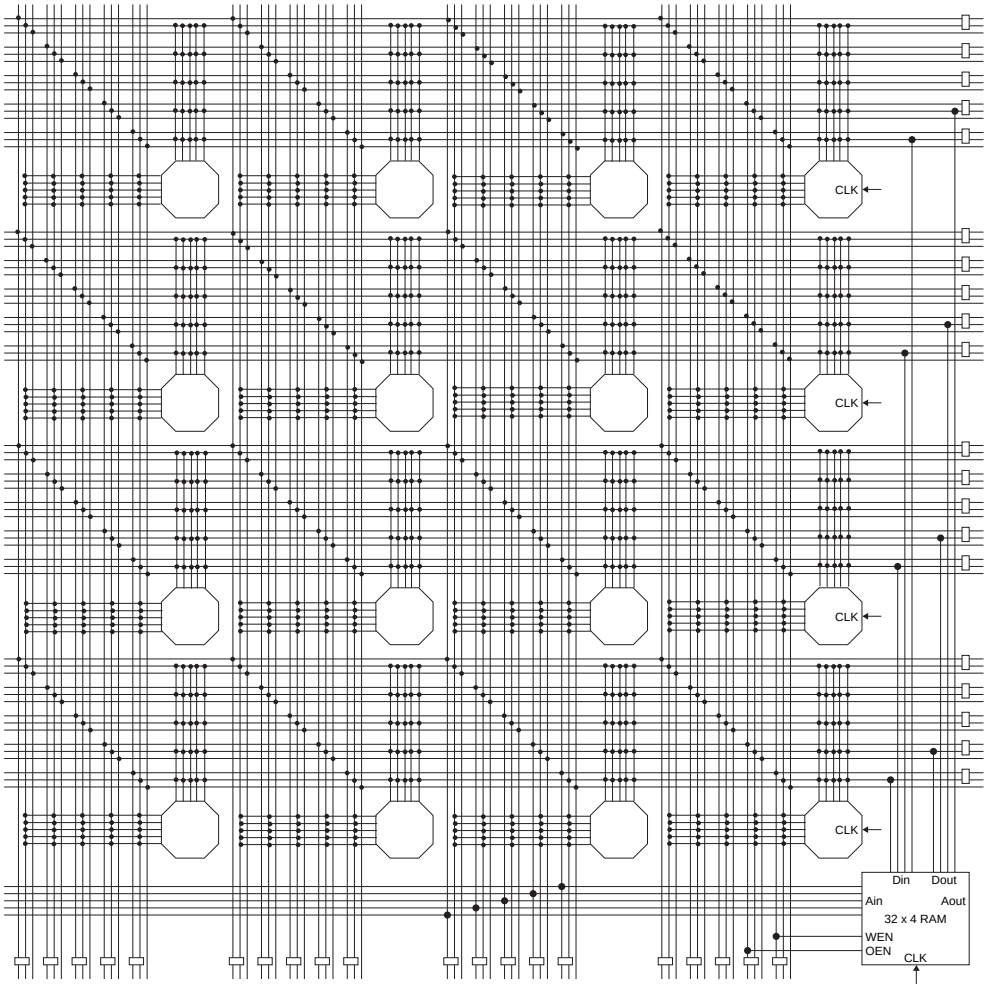
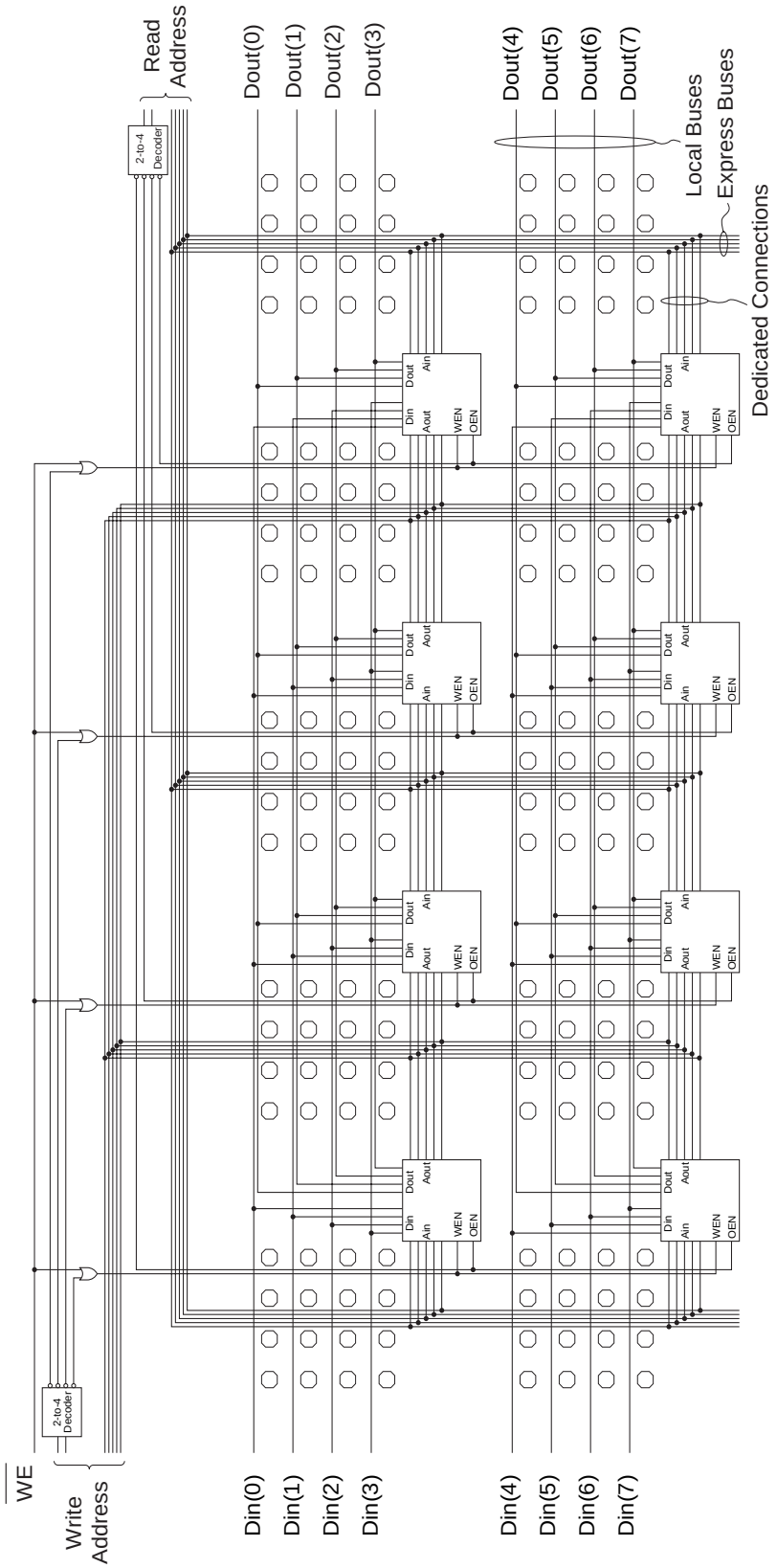


Figure 9. RAM Example: 128 x 8 Dual-ported RAM (Asynchronous)



Set/Reset Scheme

The AT40KAL family reset scheme is essentially the same as the clock scheme except that there is only one Global Reset. A dedicated Global Set/Reset bus can be driven by any User I/O, except those used for clocking (Global Clocks or Fast Clocks). The automatic placement tool will choose the reset net with the most connections to use the global resources. You can change this by using an RSBUF component in your design to indicate the global reset. Additional resets will use the express bus network.

The Global Set/Reset is distributed to each column of the array. Like Sector Clock mux, there is Sector Set/Reset mux at every four cells. Each sector column of four cells is set/reset by a Plane 5 express bus or Global Set/Reset using the Sector Set/Reset mux, see Figure 11 on page 17. The set/reset provided to each sector column of four cells is either inverted or non-inverted using the Sector Reset mux.

The function of the Set/Reset input of a register is determined by a configuration bit in each cell. The Set/Reset input of a register is active low (logic 0) by default. Setting or Resetting of a register is asynchronous. Before configuration on power-up, a logic 1 (a high) is provided by each register (i.e., all registers are set at power-up).

Primary, Secondary and Corner I/Os

The AT40KAL has three kinds of I/Os: Primary I/O, Secondary I/O and a Corner I/O. Every edge cell except corner cells on the AT40KAL has access to one Primary I/O and two Secondary I/Os.

Primary I/O

Every logic cell at the edge of the FPGA array has a direct orthogonal connection to and from a Primary I/O cell. The Primary I/O interfaces directly to its adjacent core cell. It also connects into the repeaters on the row immediately above and below the adjacent core cell. In addition, each Primary I/O also connects into the busing network of the three nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Primary I/O can be accessed from any logic cell on three separate rows or columns of the FPGA. See Figure 12 on page 20.

Secondary I/O

Every logic cell at the edge of the FPGA array has two direct diagonal connections to a Secondary I/O cell. The Secondary I/O is located between core cell locations. This I/O connects on the diagonal inputs to the cell above and the cell below. It also connects to the repeater of the cell above and below. In addition, each Secondary I/O also connects into the busing network of the two nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Secondary I/O can be accessed from any logic cell on two rows or columns of the FPGA. See Figure 13 on page 20.

Corner I/O

Logic cells at the corner of the FPGA array have direct-connect access to five separate I/Os: 2 Primary, 2 Secondary and 1 Corner I/O. Corner I/Os are like an extra Secondary I/O at each corner of the array. With the inclusion of Corner I/Os, an AT40KAL FPGA with n x n core cells always has 8n I/Os. As the diagram shows, Corner I/Os can be accessed both from the corner logic cell and the horizontal and vertical busing networks running along the edges of the array. This means that many different edge logic cells can access the Corner I/Os. See Figure 14 on page 21.

Figure 12. West Primary I/O (Mirrored for East I/O)

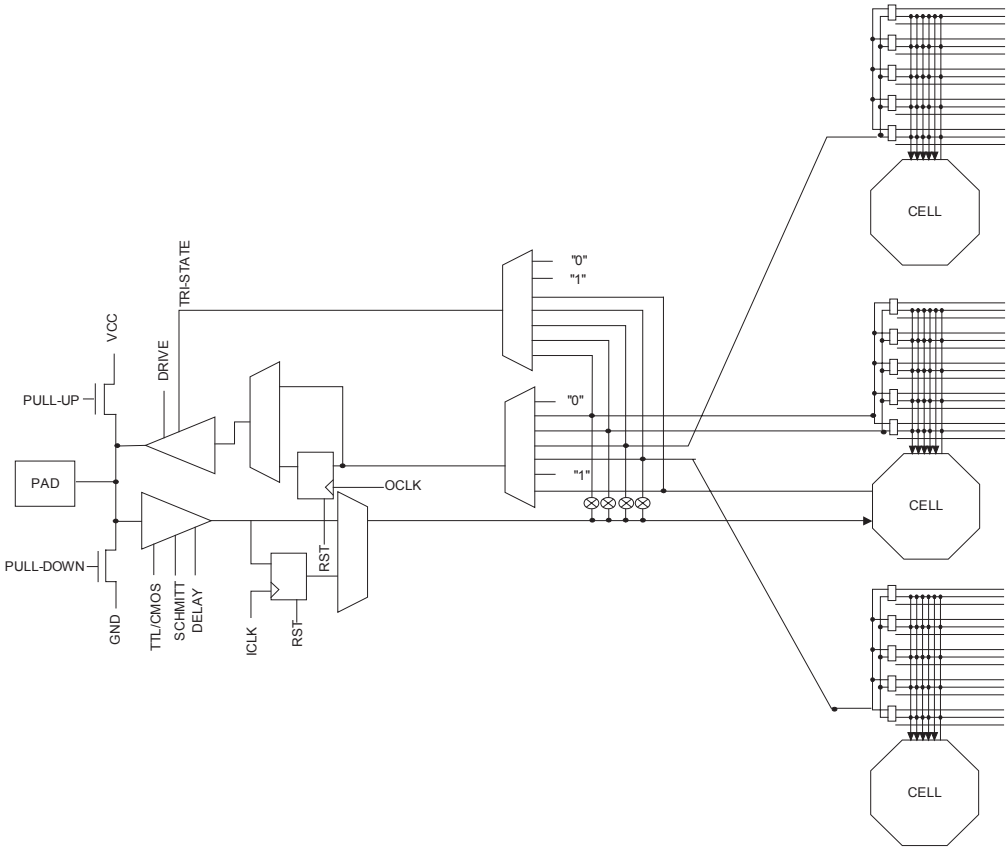


Figure 13. West Secondary I/O (Mirrored for East I/O)

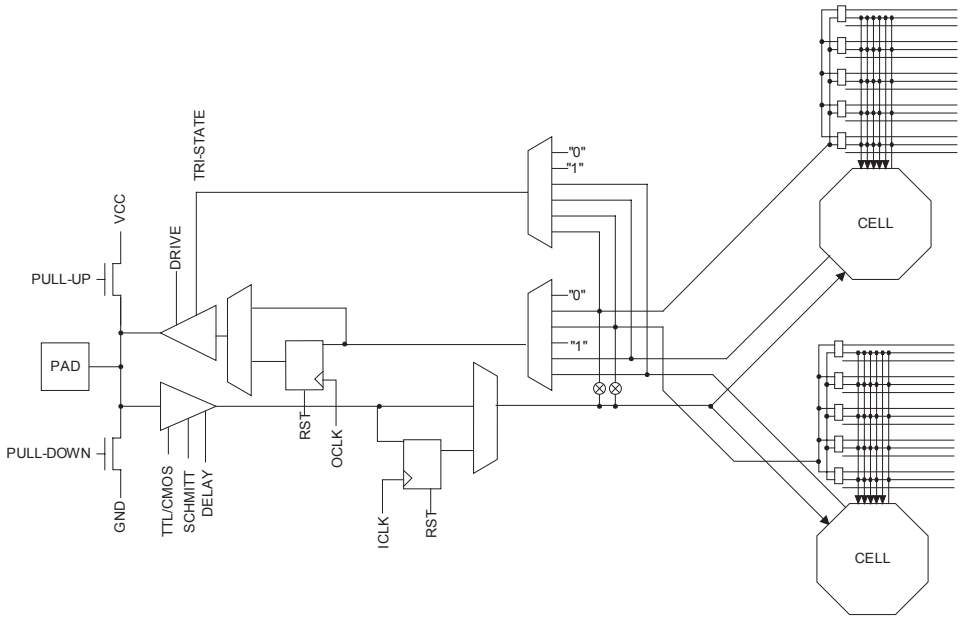
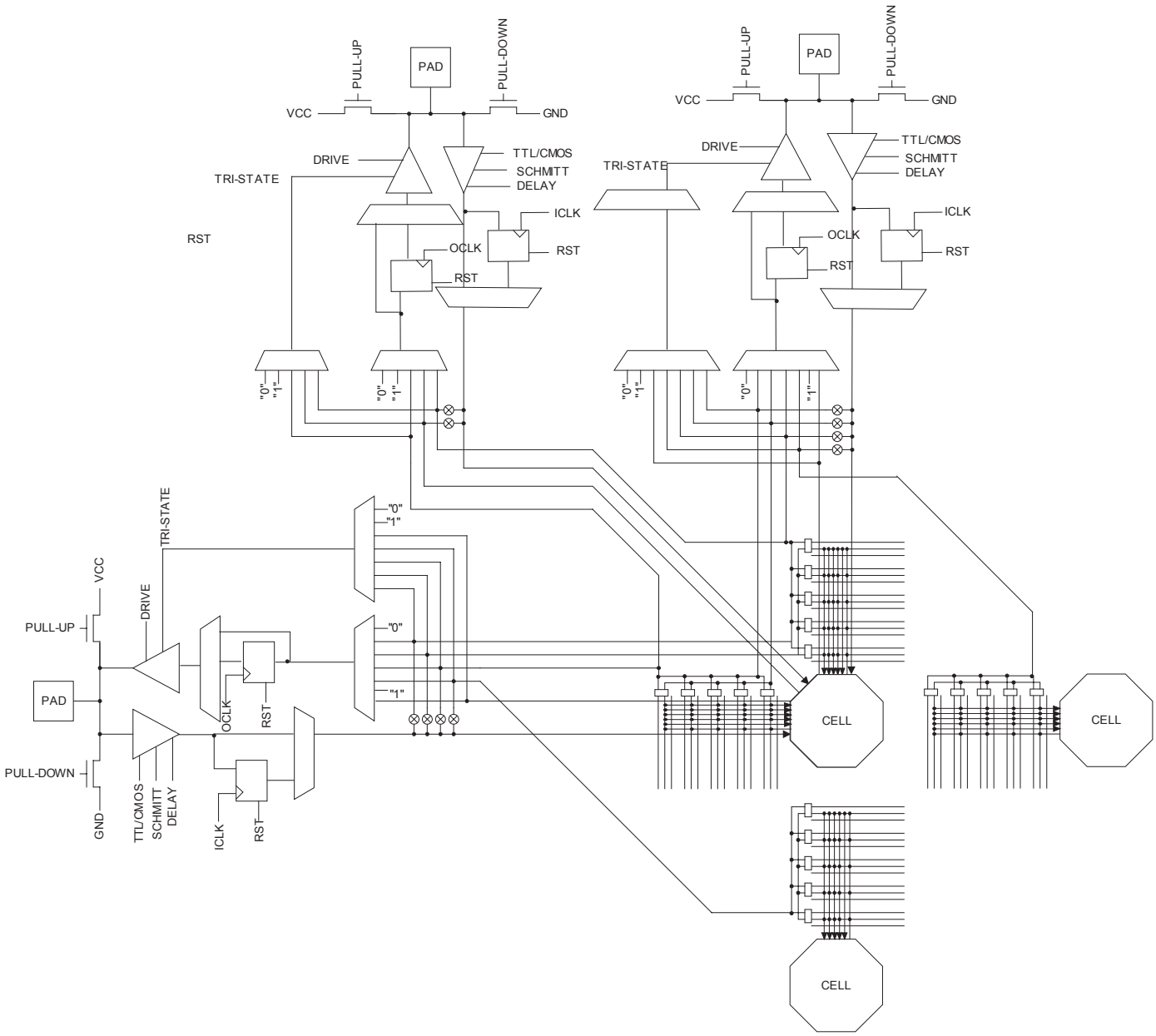


Figure 14. Northwest Corner I/O (Similar NE/SE/SW Corners)



Power-On Power Supply Requirements

Atmel FPGAs require a minimum rated power supply current capacity to insure proper initialization, and the power supply ramp-up time does affect the current required. A fast ramp-up time requires more current than a slow ramp-up time.

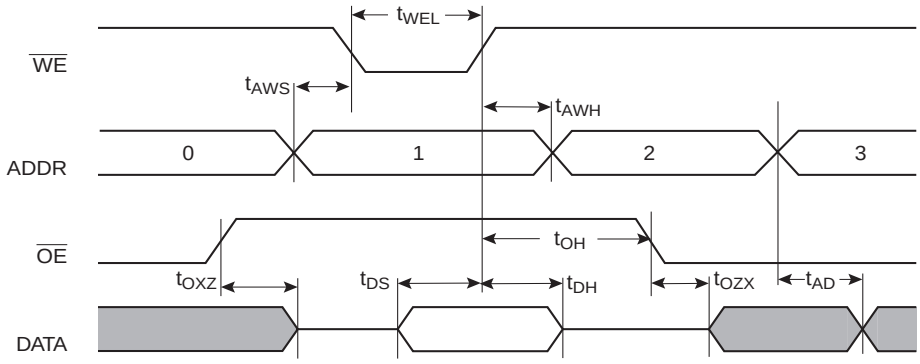
Table 3. Power-On Power Supply Requirements[1]

Device	Description	Maximum Current[2][3]
AT40K05AL AT40K10AL	Maximum Current Supply	50 mA
AT40K20AL AT40K40AL	Maximum Current Supply	100 mA

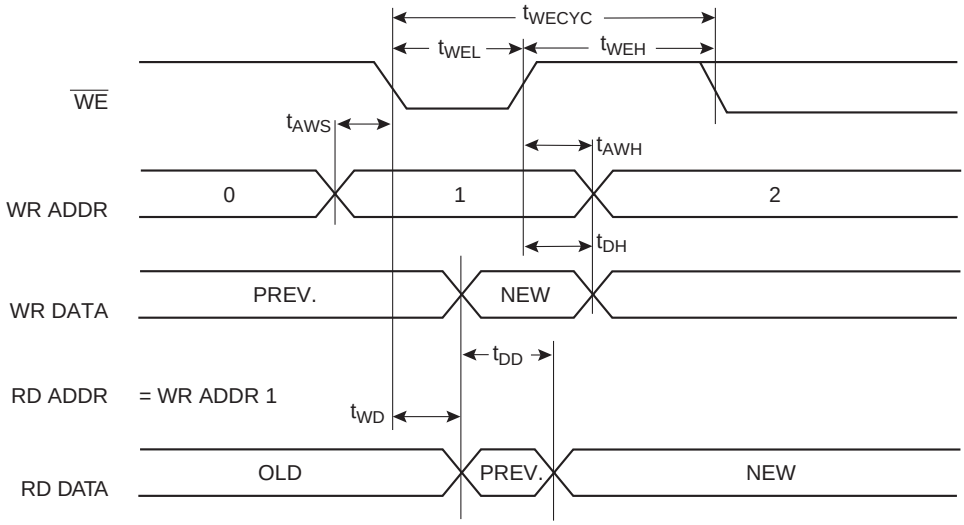
Notes:
1. This specification applies to Commercial and Industrial grade products only.
2. Devices are guaranteed to initialize properly at 50% of the minimum current listed above. A larger capacity power supply may result in a larger initialization current.
3. Ramp-up time is measured from 0 V DC to 3.6 V DC. Peak current required lasts less than 2 ms, and occurs near the internal power on reset threshold voltage.

FreeRAM Asynchronous Timing Characteristics

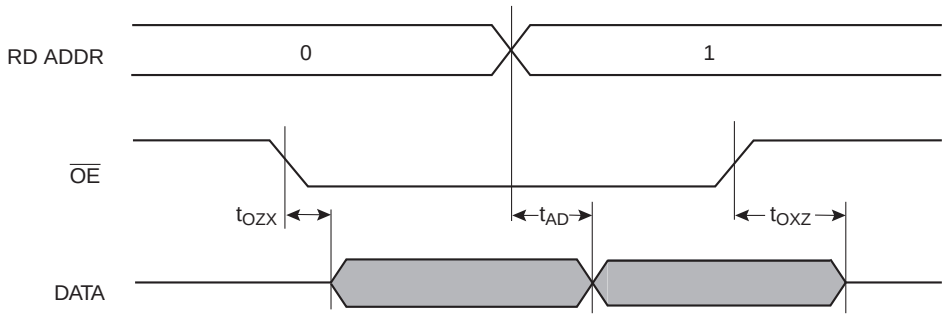
Single-port Write/Read



Dual-port Write with Read



Dual-port Read



AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Left Side (Top to Bottom)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
	I/O38	I/O52	I/O76					47
			I/O77					
			I/O78					
			GND					
			I/O79					
			I/O80					
	I/O39	I/O53	I/O81				38	48
	I/O40	I/O54	I/O82				39	49
I/O25	I/O41	I/O55	I/O83				40	50
I/O26	I/O42	I/O56	I/O84				41	51
		GND	GND					
		VCC	VCC					
		I/O57	I/O85					
		I/O58	I/O86					
			I/O87					
			I/O88					
I/O27	I/O43	I/O59	I/O89	27	18	28	42	52
I/O28	I/O44	I/O60	I/O90		19	29	43	53
			GND					
			I/O91					
			I/O92					
I/O29	I/O45	I/O61	I/O93			30	44	54
I/O30	I/O46	I/O62	I/O94			31	45	55
I/O31 ($\overline{OTS}$)[1]	I/O47 ($\overline{OTS}$)[1]	I/O63 ($\overline{OTS}$)[1]	I/O95 ($\overline{OTS}$)[1]	28	20	32	46	56
I/O32, GCK2	I/O48, GCK2	I/O64, GCK2	I/O96, GCK2	29	21	33	47	57
M1	M1	M1	M1	30	22	34	48	58
GND	GND	GND	GND	31	23	35	49	59
M0	M0	M0	M0	32	24	36	50	60

Note: 1. On-chip tri-state

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Bottom Side (Left to Right)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
			I/O174					
			GND					
			I/O175					
			I/O176					
	I/O87	I/O117	I/O177				91	109
	I/O88	I/O118	I/O178				92	110
I/O57	I/O89	I/O119	I/O179				93	111
I/O58	I/O90	I/O120	I/O180				94	112
		GND	GND					
		VCC	VCC					
		I/O121	I/O181					
		I/O122	I/O182					
I/O59 (D10)	I/O91 (D10)	I/O123 (D10)	I/O183 (D10)	48	45	65	95	113
I/O60 (D9)	I/O92 (D9)	I/O124 (D9)	I/O184 (D9)	49	46	66	96	114
			I/O185					
			I/O186					
			GND					
			I/O187					
			I/O188					
I/O61	I/O93	I/O125	I/O189			67	97	115
I/O62	I/O94	I/O126	I/O190			68	98	116
I/O63 (D8)	I/O95 (D8)	I/O127 (D8)	I/O191 (D8)	50	47	69	99	117
I/O64, GCK4	I/O96, GCK4	I/O128, GCK4	I/O192, GCK4	51	48	70	100	118
GND	GND	GND	GND	52	49	71	101	119
$\overline{\text{CON}}$	$\overline{\text{CON}}$	$\overline{\text{CON}}$	$\overline{\text{CON}}$	53	50	72	103	120

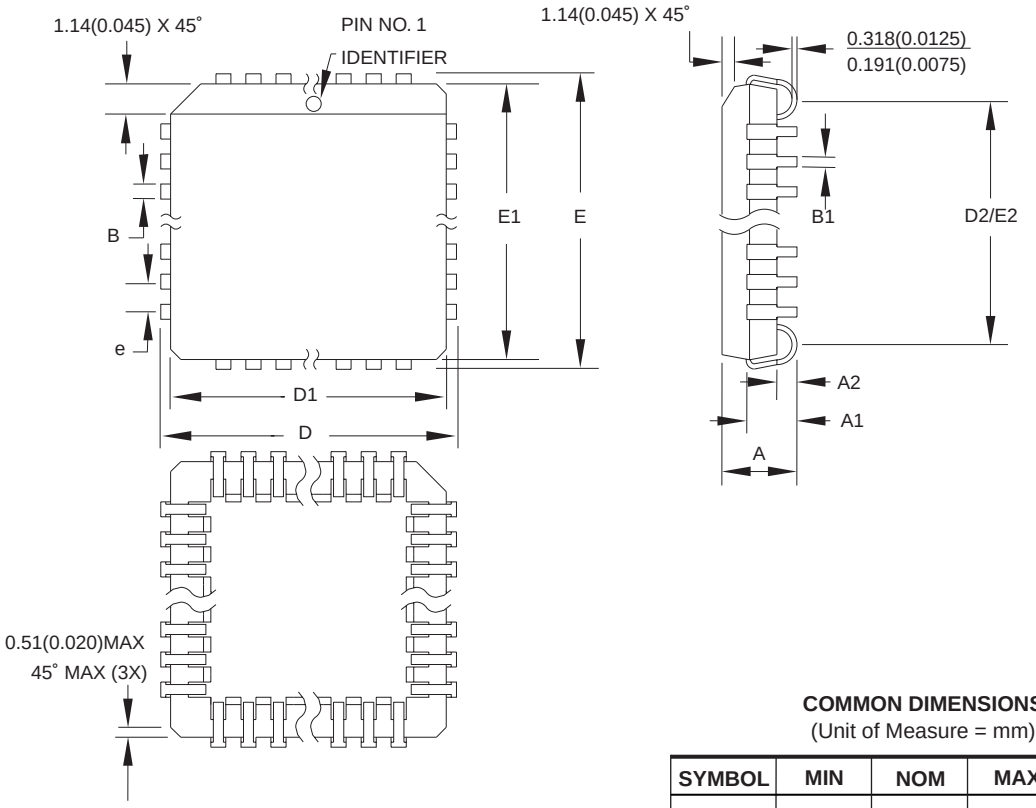
AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O73, FCK3	I/O111, FCK3	I/O147, FCK3	I/O219, FCK3			82	120	138
I/O74	I/O112	I/O148	I/O220			83	121	139
	VCC	VCC	VCC					140
I/O75 (D5)	I/O113 (D5)	I/O149 (D5)	I/O221 (D5)	59	57	84	122	141
I/O76 (CS0)	I/O114 (CS0)	I/O150 (CS0)	I/O222 (CS0)	60	58	85	123	142
			GND					
			I/O223					
			I/O224					
			I/O225					
			I/O226					
		I/O151	I/O227					
		I/O152	I/O228					
		GND	GND					143
			VCC					
			I/O229					
			I/O230					
		I/O153	I/O231					
		I/O154	I/O232					
	I/O115	I/O155	I/O233				124	144
	I/O116	I/O156	I/O234				125	145
			GND					
I/O77	I/O117	I/O157	I/O235		59	86	126	146
I/O78	I/O118	I/O158	I/O236		60	87	127	147
			I/O237					
			I/O238					
I/O79(D4)	I/O119(D4)	I/O159(D4)	I/O239(D4)	61	61	88	128	148
I/O80	I/O120	I/O160	I/O240	62	62	89	129	149
VCC	VCC	VCC	VCC	63	63	90	130	150
GND	GND	GND	GND	64	64	91	131	151
I/O81 (D3)	I/O121 (D3)	I/O161 (D3)	I/O241 (D3)	65	65	92	132	152
I/O82 ($\overline{\text{CHECK}}$)	I/O122 ($\overline{\text{CHECK}}$)	I/O162 ($\overline{\text{CHECK}}$)	I/O242 ($\overline{\text{CHECK}}$)	66	66	93	133	153

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
		I/O242	I/O362					
	I/O181	I/O243	I/O363				195	228
	I/O182	I/O244	I/O364				196	229
			I/O365					
			I/O366					
			GND					
			I/O367					
			I/O368					
I/O121	I/O183	I/O245	I/O369				197	230
I/O122	I/O184	I/O246	I/O370				198	231
I/O123 (A12)	I/O185 (A12)	I/O247 (A12)	I/O371 (A12)	7	96	138	199	232
I/O124 (A13)	I/O186 (A13)	I/O248 (A13)	I/O372 (A13)	8	97	139	200	233
		GND	GND					
		VCC	VCC					
		I/O249	I/O373					
		I/O250	I/O374					
			I/O375					
			I/O376					
			I/O377					
			I/O378					
			GND					
	I/O187	I/O251	I/O379					234
	I/O188	I/O252	I/O380					235
I/O125	I/O189	I/O253	I/O381			140	201	236
I/O126	I/O190	I/O254	I/O382			141	202	237
I/O127 (A14)	I/O191 (A14)	I/O255 (A14)	I/O383 (A14)	9	98	142	203	238
I/O128, GCK8 (A15)	I/O192, GCK8 (A15)	I/O256, GCK8 (A15)	I/O384, GCK8 (A15)	10	99	143	204	239
VCC	VCC	VCC	VCC	11	100	144	205	240

Note: 1. Shared with TSTCLK. No Connect.

Packaging Information

84J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

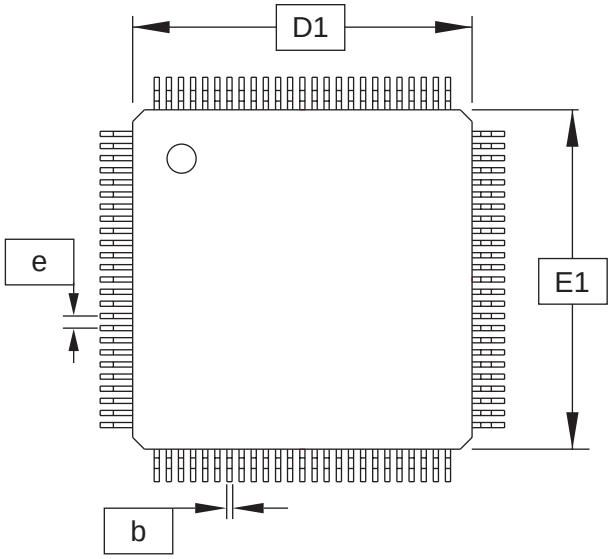
SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	–	4.572	
A1	2.286	–	3.048	
A2	0.508	–	–	
D	30.099	–	30.353	
D1	29.210	–	29.413	Note 2
E	30.099	–	30.353	
E1	29.210	–	29.413	Note 2
D2/E2	27.686	–	28.702	
B	0.660	–	0.813	
B1	0.330	–	0.533	
e	1.270 TYP			

Notes:
1. This package conforms to JEDEC reference MS-018, Variation AF.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
3. Lead coplanarity is 0.004" (0.102 mm) maximum.

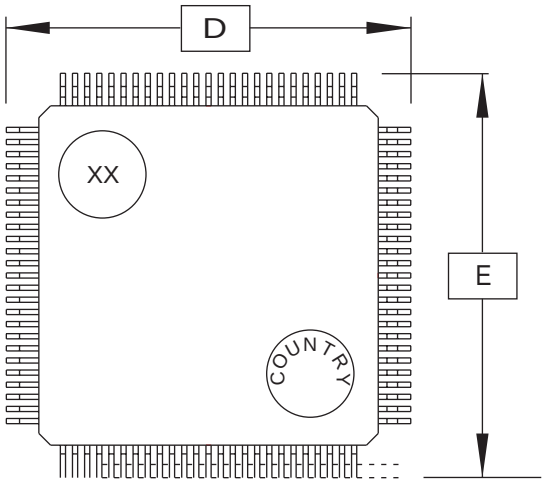
10/04/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**84J**, 84-lead, Plastic J-leaded Chip Carrier (PLCC)	84J	B

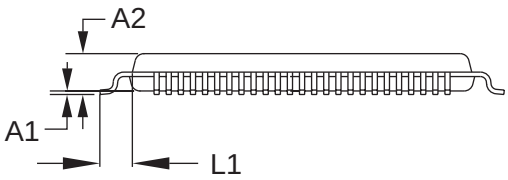
100T1 – TQFP



Top View



Bottom View



Side View

COMMON DIMENSIONS
(Unit of Measure = mm)

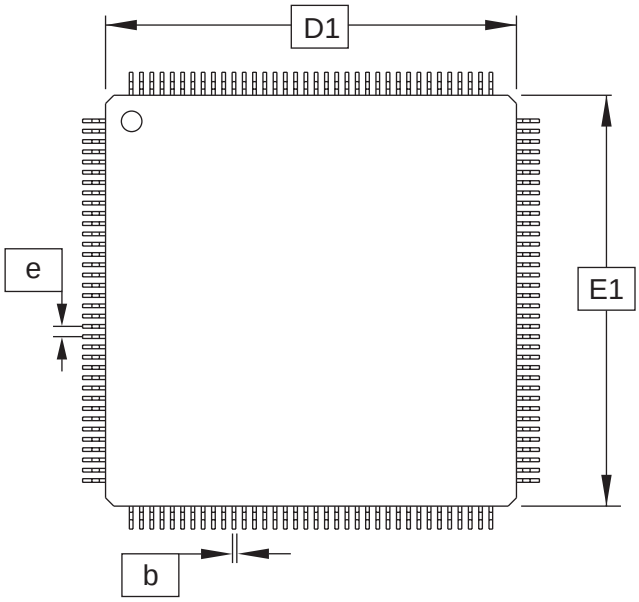
SYMBOL	MIN	NOM	MAX	NOTE
A1	0.05		0.15	6
A2	0.95	1.00	1.05	
D		16.00 BSC		
D1		14.00 BSC		2, 3
E		16.00 BSC		
E1		14.00 BSC		2, 3
e		0.50 BSC		
b	0.17	0.22	0.27	4, 5
L1		1.00 REF		

Notes:
1. This drawing is for general information only. Refer to JEDEC Drawing MO-153, Variation AA, for proper dimensions, tolerances, datums, etc.
2. The top package body size may be smaller than the bottom package size by as much as 0.15 mm.
3. Dimensions D1 and E1 do not include mold protrusions. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions, including mold mismatch.
4. Dimension b does not include Dambar protrusion. Allowable Dambar protrusion shall not cause the lead width to exceed the maximum b dimension by more than 0.08 mm. Dambar cannot be located on the lower radius or the foot. Minimum space between protrusion and an adjacent lead is 0.07 mm for 0.4 and 0.5 mm pitch packages.
5. These dimensions apply to the flat section of the lead between 0.10 mm and 0.25 mm from the lead tip.
6. A1 is defined as the distance from the seating place to the lowest point on the package body.

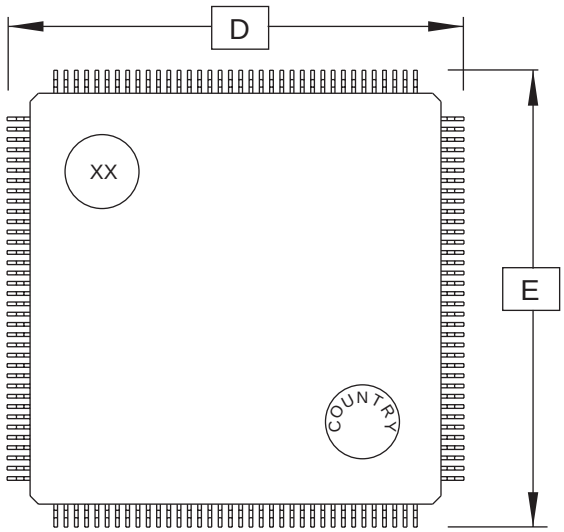
11/30/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**100T1**, 100-lead (14 x 14 x 1.0 mm Body), Thin Plastic Quad Flat Pack (TQFP)	100T1	A

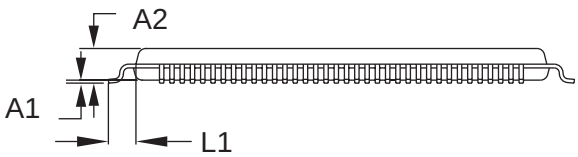
144L1 – LQFP



Top View



Bottom View



Side View

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A1	0.05		0.15	6
A2	1.35	1.40	1.45	
D	22.00 BSC			
D1	20.00 BSC			2, 3
E	22.00 BSC			
E1	20.00 BSC			2, 3
e	0.50 BSC			
b	0.17	0.22	0.27	4, 5
L1	1.00 REF			

Notes:
1. This drawing is for general information only; refer to JEDEC Drawing MS-026 for additional information.
2. The top package body size may be smaller than the bottom package size by as much as 0.15 mm.
3. Dimensions D1 and E1 do not include mold protrusions. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions including mold mismatch.
4. Dimension b does not include Dambar protrusion. Allowable Dambar protrusion shall not cause the lead width to exceed the maximum b dimension by more than 0.08 mm. Dambar cannot be located on the lower radius or the foot. Minimum space between protrusion and an adjacent lead is 0.07 mm for 0.4 and 0.5 mm pitch packages.
5. These dimensions apply to the flat section of the lead between 0.10 mm and 0.25 mm from the lead tip.
6. A1 is defined as the distance from the seating place to the lowest point on the package body.

11/30/01

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**144L1**, 144-lead (20 x 20 x 1.4 mm Body), Low Profile Plastic Quad Flat Pack (LQFP)	144L1	A